

**Claim of common ownership under 35 USC 103(c)(1):**

The undersigned attorney indicates that, at the time of the invention of the subject matter in the present application, serial number 10/826419, Axcelis Technologies, Inc. owned both the present application and United States patent number 7,010,388 B2 to Mitchell et al. This statement is presented under MPEP section 706.02(l)(2). The assignment of the present application to Axcelis Technologies, Inc. is recorded at reel 015230 frame 0863 of the records of the United States Patent and Trademark Office and the assignment of the '388 patent to Mitchell et al is recorded at reel 014123, frame 0472.

Claim Status

1. (previously presented) For use with a tool for processing a work-piece at low pressure, a work-piece transfer system comprising:

- a) a first isolation load lock for transferring a work-piece from a higher pressure region to a lower pressure region and back to said higher pressure region;
- b) a second isolation load lock positioned next to the first work-piece isolation load lock for transferring a work-piece from a higher pressure region to a lower pressure region and back to said higher pressure region;
- c) a work-piece processing station for processing work-pieces at low pressure;
- d) a robot for transferring work-pieces from one of said first and second work-piece isolation load locks to the work-piece processing station; and
- e) wherein said first and second isolation load locks are housed within a load lock housing, said load lock housing including two load lock access openings facing said higher pressure region at different angles to allow each of the first and second load locks to be accessed from two different directions.

2. (original) The transfer system of claim 1 additionally comprising a work-piece aligner for controlling an alignment of work-pieces moved through the work-piece isolation load lock.

3. (previously presented) The transfer system of claim 1 wherein said housing includes a support for supporting a work-piece placed on the support within the housing interior; and

a control valve for selectively venting a load lock housing interior to atmosphere and to a vacuum source for lowering the pressure within the load lock housing interior.

4. (original) The transfer system of claim 1 wherein the first and second isolation load locks are spaced vertically from each other and wherein the robot includes two spaced apart end effectors that can be moved into the first and second isolation load locks to obtain a work-piece.

5. (original) The transfer system of claim 4 wherein the spaced apart end effectors can be raised and lowered in relation to the load locks to allow either end effector to move into either of said first or second load locks.

6. (previously presented) For use with a tool for processing a work-piece at low pressure, transfer apparatus comprising:

a) an enclosure defining a low pressure region for processing of work-pieces at a work-piece processing station within the low pressure region;

b) two adjacent work-piece isolation load locks wherein each load lock includes:

i) two access openings for selectively communicating atmospheric pressure to a load lock interior for transferring work-pieces to and from a region of atmospheric pressure wherein said two access openings confront said region of atmospheric pressure at different angles, and

ii) a third access opening for transferring work-pieces within the load lock interior to lower pressure for processing and back to said higher pressure subsequent to said processing;

c) a first robot for transferring work-pieces from the adjacent work-piece isolation load locks to a processing station within the low pressure region; and

d) multiple other robots positioned in said atmospheric region outside the low pressure region for transferring work-pieces to and from the adjacent work-piece isolation load locks from a source of said work-pieces prior to processing and to a destination of said work-pieces after said processing wherein each of said multiple other robots is aligned with at least one of said access openings.

7. (original) The transfer apparatus of claim 6 wherein the adjacent work-piece isolation load locks are positioned one on top of the other.

8. (original) The transfer apparatus of claim 7 wherein the two access openings of a load lock open to allow work-pieces to be inserted along different travel paths and placed on a load lock support.

9. (previously presented) The transfer apparatus of claim 6 wherein the first robot moves the work-pieces in an arc to a transfer station.

10. (original) The transfer apparatus of claim 9 wherein the first robot has two end effectors, wherein each end effector can actively grasp a work-piece in either load lock.

11. (original) The transfer apparatus of claim 10 wherein the load locks are positioned one on top of the other and the work-pieces are generally flat wafers and further wherein the two end effectors move up and down along a direction transverse to a plane of the generally flat wafers.

12. (original) The transfer apparatus of claim 11 wherein the two end effectors are coupled to a movable carriage that moves the two end effectors simultaneously.

13. (previously presented) A process for serially processing multiple work-pieces at low pressure comprising:

providing a low pressure robot having two end effectors for moving work-pieces to a processing station from first and second load locks positioned adjacent to each other;

moving an unprocessed work-piece to a first load lock through a first atmospheric load lock access opening and placing the unprocessed work-piece inside the first load lock;

lowering the pressure within the first load lock;

removing the unprocessed work-piece from the first load lock with one end effector of said low pressure robot and moving the unprocessed work-piece to a processing station;

placing an already processed work-piece obtained from the processing station with a second end effector of said low pressure robot into one load lock of said first or second load locks;

raising the pressure within the one load lock; and

removing the processed work-piece from the one load lock through a second atmospheric load lock access opening.

14. (original) The process of claim 13 wherein a processed work-piece is placed into the one load lock at the same time an unprocessed work-piece is being processed at the processing station.

15. (original) The process of claim 14 wherein the work-piece is a semiconductor wafer and wherein the low pressure robot delivers the wafer for placement onto a wafer chuck that attracts the wafer and further comprising reorienting the wafer and chuck prior to processing.

16. (original) The process of claim 13 comprising positioning one load lock above the second load lock.

17. (original) The process of claim 16 comprising moving the two end effectors of the low pressure robot up and down to enable either end effector to access work-pieces within either the first or second load locks.

18. (original) The process of claim 17 wherein the two end effectors are mounted collinearly to each other on a carriage that supports a drive motor for independently activating each end effector and further comprising moving the carriage up and down with respect to the load locks to appropriately position an end effector with respect to a load lock.

19. (previously presented) The process of claim 13 wherein the first and second atmospheric load lock access openings are located at an angle with respect to each other for allowing work-pieces to be inserted into a load lock from different directions from an in air side of said load lock and further comprising positioning multiple in air robots for moving work-pieces into and out of said load locks.

20. (original) The process of claim 13 wherein the work-piece is a generally planar wafer and additionally comprising aligning an orientation of the wafer prior to inserting an unprocessed wafer into a load lock.

21. (original) The process of claim 20 additionally comprising providing first and second in air robots for moving the generally planar wafers to and from the load lock and wherein a first in air robot gathers a wafer from a source of wafers, places an unprocessed wafer onto an aligner for orientation and wherein a second in air robot removes an aligned wafer from the aligner for transfer through a load lock to the processing station.

22. (original) The process of claim 13 wherein one or more additional unprocessed work pieces are moved sequentially from a source by an in air robot to the first and second load locks prior to removal of the processed work piece from the one load lock.

23. (original) The process of claim 22 wherein alternate ones of the additional unprocessed work pieces are placed into alternate load locks of said first and second load locks to allow a predecessor work piece to be removed from a pumped down load lock while an alternate load lock is opened to atmosphere for receipt of an unprocessed work piece.

24. (original) The process of claim 13 wherein a given work piece is removed after processing from the same load lock into which said given work piece was placed prior to processing.

25. (previously presented) Apparatus for serially processing multiple work-pieces at low pressure comprising:

first and second load locks located adjacent to each other and housed within a load lock housing, said load lock housing including two load lock access openings facing a higher pressure

region at different angles to allow each of the first and second load locks to be accessed from two different directions from said higher pressure region;

a first low pressure robot having two end effectors which rotate about a robot center axis for moving work-pieces from the first and second loadlocks to a processing station;

a second in air robot for moving an unprocessed work-piece to a first loadlock and placing the unprocessed work-piece inside the first loadlock;

a pump for evacuating the first loadlock to reduce the pressure within the first loadlock;  
and

a controller for causing the first robot to remove the unprocessed work-piece from the first loadlock with one end effector of said first robot and placing a processed work-piece obtained from the processing station with a second end effector of said first robot into the second loadlock prior to pressurizing the second load lock.